



Vishay Siliconix

N-Channel 30-V (D-S) MOSFET

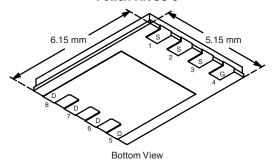
PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)	
30	0.0047 at $V_{GS} = 10 \text{ V}$	40 ^g	16.8 nC	
30	0.0061 at $V_{GS} = 4.5 \text{ V}$	40 ^g	10.6110	

FEATURES

- Halogen-free According to IEC 61249-2-21
- TrenchFET[®] Gen III Power MOSFET
- 100 % R_q Tested
- 100 % Avalanche Tested



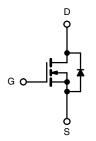




Ordering Information: SiR460DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

APPLICATIONS

- · Notebook Vcore
- DC/DC



N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	30	V		
Gate-Source Voltage		V_{GS}	± 20	v	
	T _C = 25 °C		40 ^g		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	L .	40 ^g	A	
Continuous Brain Guirent (1) = 130 C)	T _A = 25 °C	I _D	24.3 ^{b, c}		
	T _A = 70 °C		19.4 ^{b, c}		
Pulsed Drain Current		I _{DM}	70		
Continuous Source-Drain Diode Current	T _C = 25 °C	l _a	40 ^g		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	4.5 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	30		
Single Pulse Avalanche Energy	L = 0.1 IIII1	E _{AS}	45	mJ	
	T _C = 25 °C		48	w	
Maximum Power Dissipation	T _C = 70 °C	P _D	31		
Maximum Fower Dissipation	T _A = 25 °C	' D	5.0 ^{b, c}		
	T _A = 70 °C		3.2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperatur		260			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 10 s	R _{thJA}	20	25	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	2.1	2.6	- 0/00	

Notes:

- a. Based on $T_C = 25$ °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s
- d. See Solder Profile (<u>www.vishay.com/ppg?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 65 °C/W.
- g. Package Limited.

SiR460DP

Vishay Siliconix



Parameter	, unless oth	Test Conditions	Min.	Typ.	Max.	Unit	
Static	,					l	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	30			V	
V _{DS} Temperature Coefficient	ΔVns/T1			29			
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 5.5		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.0		2.4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current		V _{DS} = 30 V, V _{GS} = 0 V			1	μΑ	
	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
		V _{GS} = 10 V, I _D = 15 A		0.0038	0.0047	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 10 A		0.0049	0.0061		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		60		S	
Dynamic ^b							
Input Capacitance	C _{iss}			2071			
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		406		pF	
Reverse Transfer Capacitance	C _{rss}	50 00		168			
·		V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A		36	54	nC	
Total Gate Charge	Q_g	26 4 65 7 2		16.8	25.5		
Gate-Source Charge	Q _{gs}	V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 10 A		5.1			
Gate-Drain Charge	Q_{gd}			5.2			
Gate Resistance	R_{g}	f = 1 MHz	0.2	0.85	1.7	Ω	
Turn-On Delay Time	t _{d(on)}			25	45	ns	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$		16	30		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		28	50		
Fall Time	t _f			12	24		
Turn-On Delay Time	t _{d(on)}			10	20		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$		9	18		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		25	45		
Fall Time	t _f			9	18		
Drain-Source Body Diode Characteris	tics				L		
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			40	^	
Pulse Diode Forward Current ^a	I _{SM}				70	- A	
Body Diode Voltage	V _{SD}	I _S = 3 A		0.73	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			19	38	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	1 10 A 41/44 100 A/44 T 05 20		10	20	nC	
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		10		ns	
Reverse Recovery Rise Time	t _b			9			

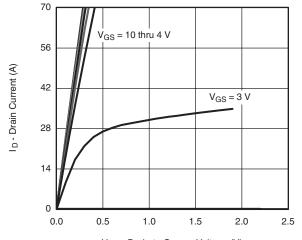
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



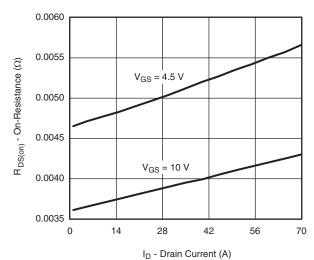
Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

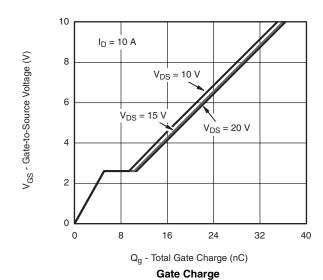


 $V_{\mbox{\footnotesize{DS}}}$ - Drain-to-Source Voltage (V)

Output Characteristics



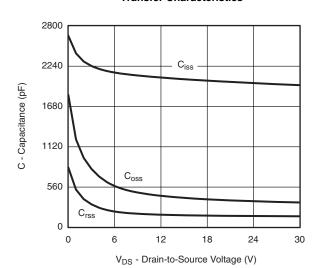
On-Resistance vs. Drain Current and Gate Voltage



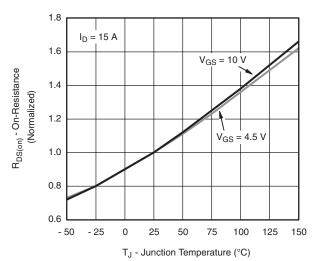
(V) to a contract of the contr

V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

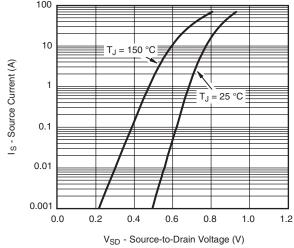
0.020

SiR460DP

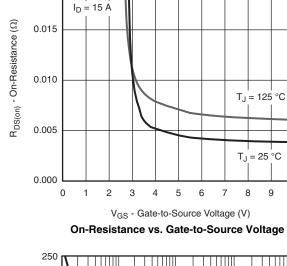
Vishay Siliconix

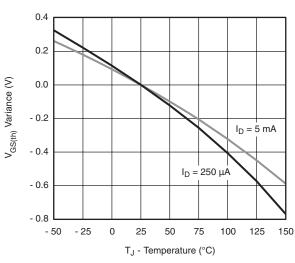
VISHAY.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

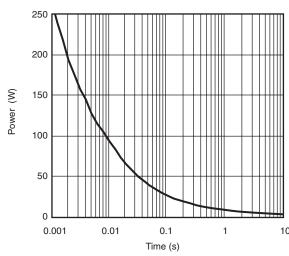


Source-Drain Diode Forward Voltage

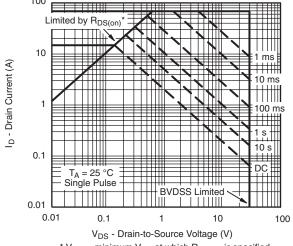




Threshold Voltage



Single Pulse Power, Junction-to-Ambient

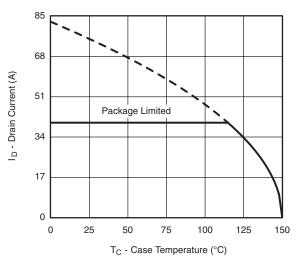


* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

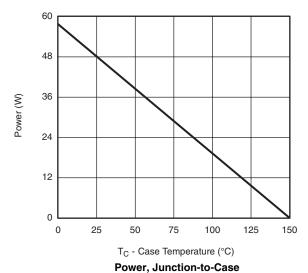
Safe Operating Area, Junction-to-Ambient

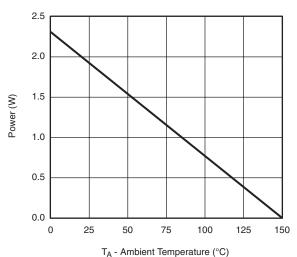
Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating*





Power, Junction-to-Ambient

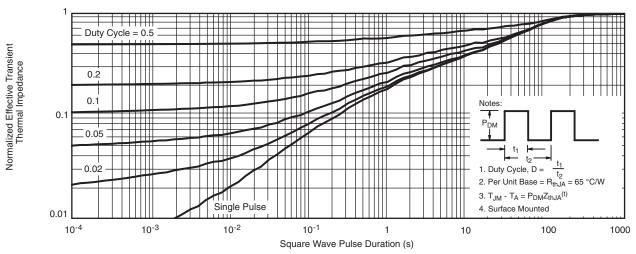
^{*} The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

SiR460DP

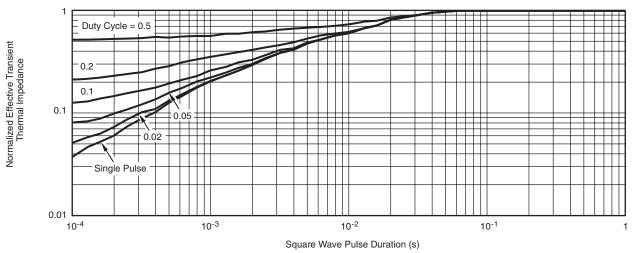
Vishay Siliconix

VISHAY.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?69095.

Downloaded from Elcodis.com electronic components distributor

Legal Disclaimer Notice



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Document Number: 91000 www.vishay.com
Revision: 11-Mar-11 1